

10W High Power SPDT Switch

■ FEATURES

Control voltage range
 2.7 V to 5.0 V

Low insertion loss

0.35 dB typ. @ 3.85 GHz, $V_{CTL}(H) = 3.3 \text{ V}$ 0.40 dB typ. @ 4.7 GHz, $V_{CTL}(H) = 3.3 \text{ V}$ 0.45 dB typ. @ 6.0 GHz, $V_{CTL}(H) = 3.3 \text{ V}$

High isolation

27dB typ. @ 3.85 GHz, $V_{CTL}(H) = 3.3$ V 27dB typ. @ 4.7 GHz, $V_{CTL}(H) = 3.3$ V 25dB typ. @ 6.0 GHz, $V_{CTL}(H) = 3.3$ V

High linearity

 $P_{-0.1dB} = +40 \text{ dBm typ.}$ @ 6.0 GHz, $V_{CTL}(H) = 3.3 \text{ V}$

• High switching speed 150 ns typ.

• Small & thin Package

EQFN12-E4 (2.0 mm x 2.0 mm x 0.397 mm typ.)

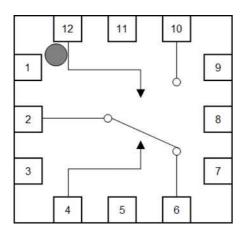
• RoHS compliant and Halogen Free, MSL1

■ APPLICATION

- 5G (Sub-6GHz) Small-cell base station
- Commercial radio application
- Transmit/receive switching, antenna switching and others switching applications

■ **BLOCK DIAGRAM** (EQFN12-E4)

(TOP VIEW)



■ GENERAL DESCRIPTION

The NJG1817ME4 is a high power SPDT switch GaAs MMIC suitable for 5G base station system, also is used commercial radio system requiring high power.

This switch has high power handing capability of +40dBm. Features are high linearity and low insertion loss up to 6GHz. Furthermore, high switching speed of the NJG1817ME4 is enough capable on 5G communications. Integrated ESD protection device on each RF port achieves excellent ESD robustness.

The NJG1817ME4 is packaged 2mm x 2mm EQFN12-E4 small size package despite its high power handling.

■ TRUTH TABLE

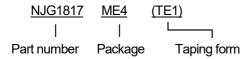
"H" = $V_{CTL}(H)$, "L" = $V_{CTL}(L)$

ON PATH	VCTL1	VCTL2
PC-P1	Н	L
PC-P2	L	Н

■PIN CONFIGURATION

PIN NO.	SYMBOL	DESCRIPTION
1	NC(GND)	No connected terminal (Connect to ground)
2	PC	Common RF terminal
3	NC(GND)	No connected terminal (Connect to ground)
4	VCTL1	Control signal input
4	VOILI	terminal.
5	NC(GND)	No connected terminal
	NC(GND)	(Connect to ground)
6	P1	RF terminal
7	GND	Ground terminal
8	GND	Ground terminal
9	GND	Ground terminal
10	P2	RF terminal
11	NC(GND)	No connected terminal (Connect to ground)
12	VCTL2	Control signal input terminal.
Exposed		Ground terminal
Pad		Oround terminal

■ PRODUCT NAME INFORMATION



■ ORDERING INFORMATION

PART NUMBER	PACKAGE OUTLINE	RoHS	HALOGEN- FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ (pcs.)
NJG1817ME4	EQFN12-E4	Yes	Yes	SnBi	1817	4.7	3,000

■ ABSOLUTE MAXIMUM RATINGS

(General conditions: T_a = +25°C)

PARAMETER	SYMBOL	RATINGS	UNIT
RF input power	P _{IN}	+40(1)	dBm
Control voltage	Vctl	6.0	V
Power dissipation ⁽²⁾	P _D	1200	mW
Operating temperature	Topr	-40 to +105	°C
Storage temperature	T _{stg}	-55 to +150	°C

^{(1):} $V_{CTL}(H) = 3.3 \text{ V}$, $V_{CTL}(L) = 0 \text{ V}$, on state port

-25

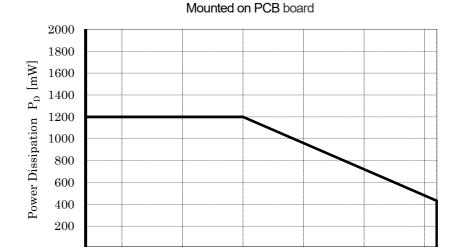
-40

0

■ POWER DISSIPATION VS.AMBIENT TEMPERATURE

Please, refer to the following Power Dissipation and Ambient Temperature. (Please note the surface mount package has a low maximum rating of Power Dissipation [P_D], a special attention should be paid in designing of thermal radiation.)

Power Dissipation—Ambient Temperature Characteristic



Ambient Temperature Ta[°C]

50

25

75

100 105

^{(2): 4-}layer FR4 PCB with through-hole (101.5 x 114.5 mm), Tj = 150°C

■ ELECTRICAL CHARACTERISTICS 1 (DC CHARACTERISTICS)

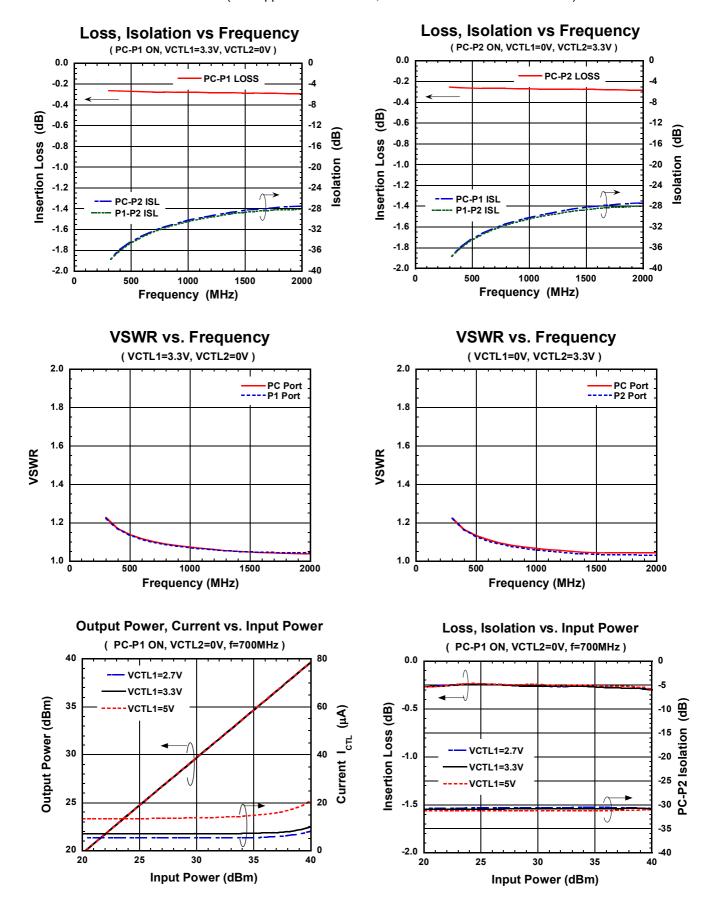
(General conditions: $T_a = +25^{\circ}C$, $Z_s = Z_l = 50 \Omega$, with application circuit)

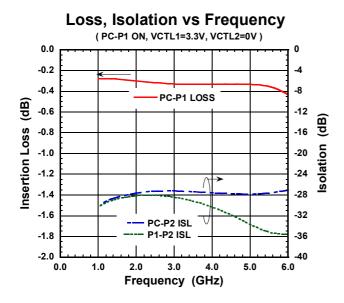
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Control voltage (HIGH)	V _{CTL} (H)		2.7	3.3	5.0	V
Control voltage (LOW)	Vcть(L)		-0.2	0	0.2	V
Control current	Ість	$V_{CTL}(H) = 3.3V, V_{CTL}(L) = 0V$	-	7	15	μΑ

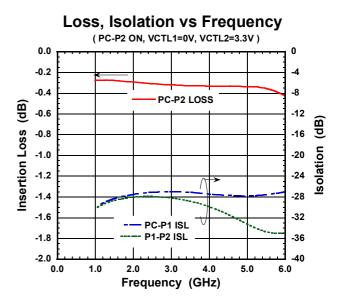
■ ELECTRICAL CHARACTERISTICS 2 (RF CHARACTERISTICS)

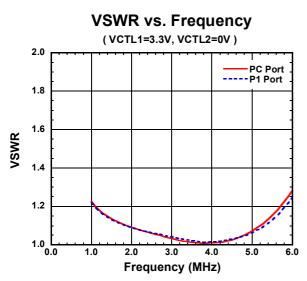
(General conditions: $V_{CTL}(H) = 3.3 \text{ V}$, $V_{CTL}(L) = 0 \text{ V}$, $T_a = +25 ^{\circ}\text{C}$, $Z_s = Z_l = 50 \Omega$, with application circuit)

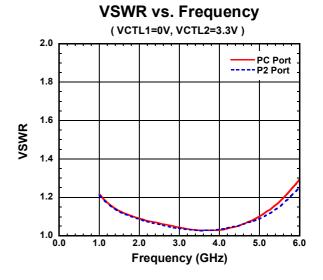
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Insertion loss	LOSS	f = 0.7GHz	-	0.30	0.45	dB
		f = 3.85 GHz	ı	0.35	0.50	
	LO33	f = 4.7 GHz	ı	0.40	0.60	
		f = 6.0 GHz	ı	0.45	0.65	
		f = 0.7 GHz	28	30	ı	
Isolation	ISL	f = 3.85 GHz	25	27	1	dB
		f = 4.7 GHz	25	27	ı	
		f = 6.0 GHz	22	25	ı	
Input power at 0.1dB compression point	P _{-0.1dB}	f = 6.0 GHz	+39	+40	ı	dBm
	VSWR	f = 0.7 GHz	-	1.1	1.3	-
VSWR		f = 3.85 GHz	-	1.1	1.3	
		f = 4.7 GHz	-	1.1	1.3	
		f = 6.0 GHz	-	1.2	1.4	
Switching time	Tsw	50% V _{CTL} to 10%/ 90% RF	-	150	350	ns

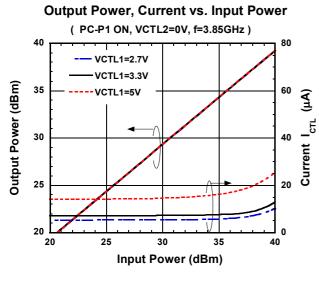


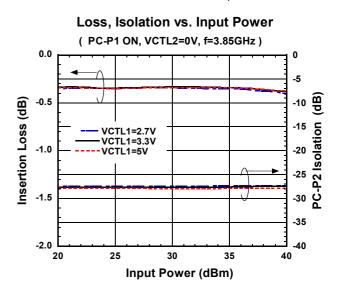


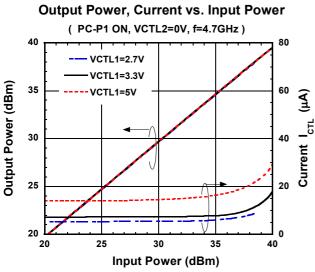


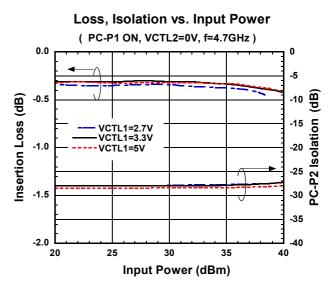


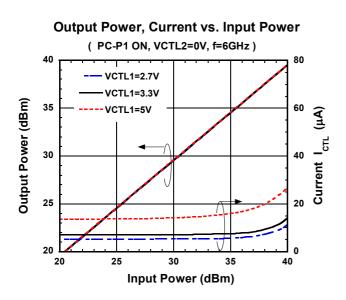


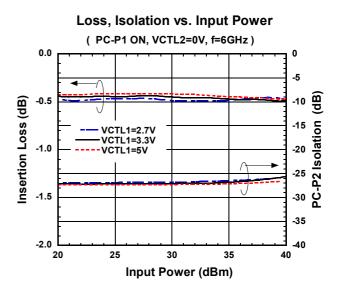


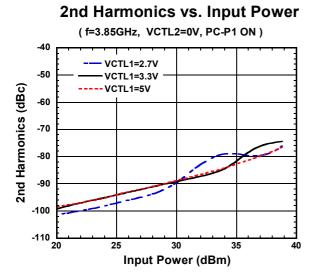


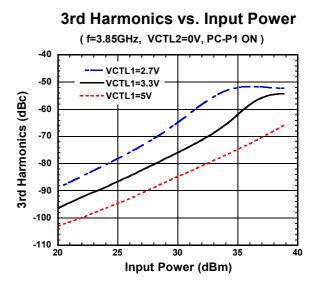


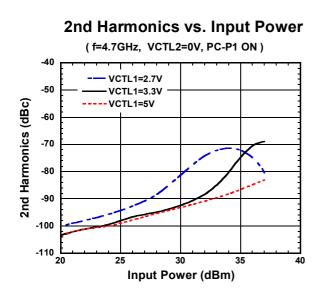


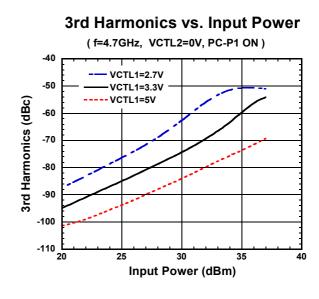


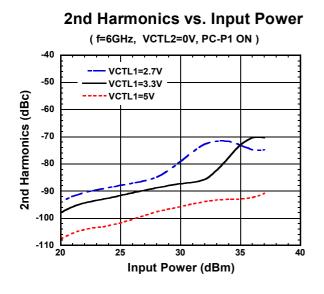


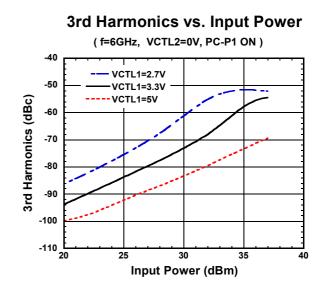


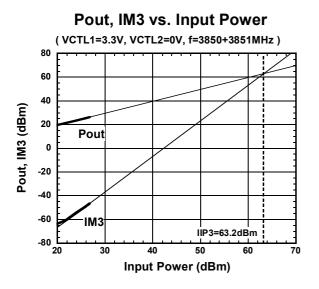


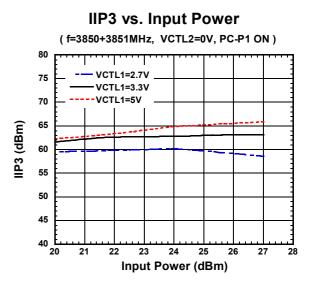


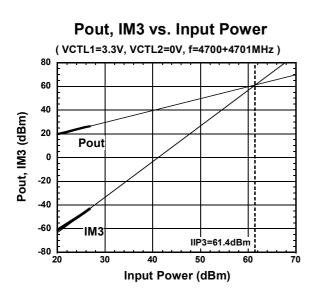


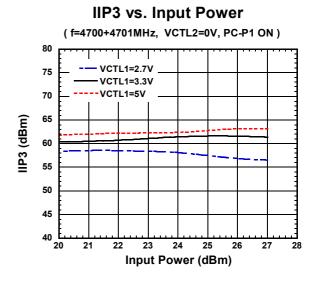


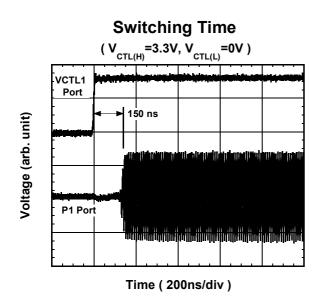


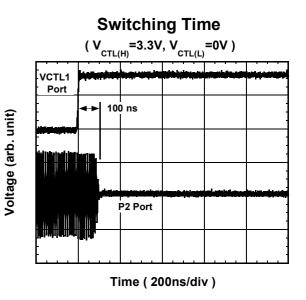


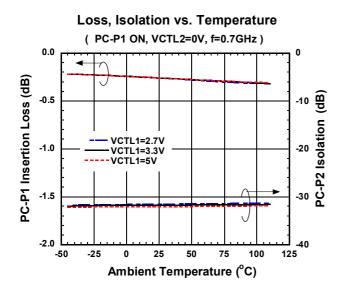


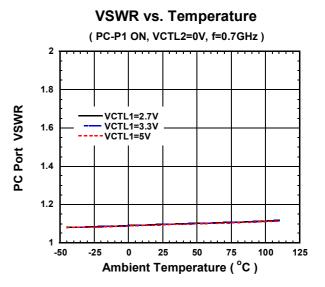


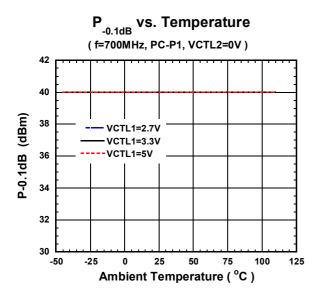


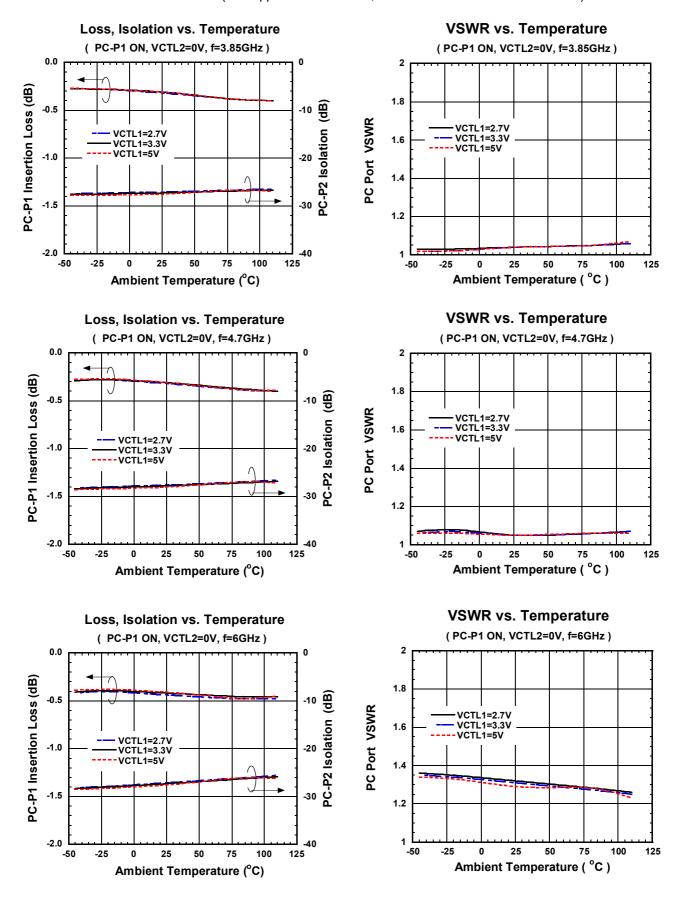


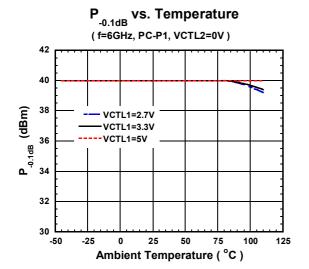


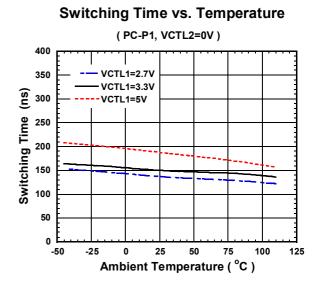




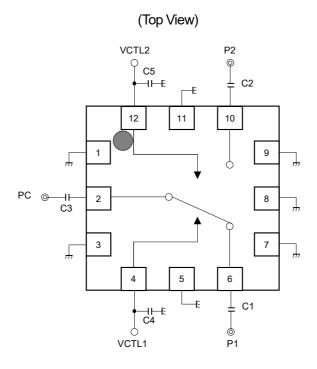








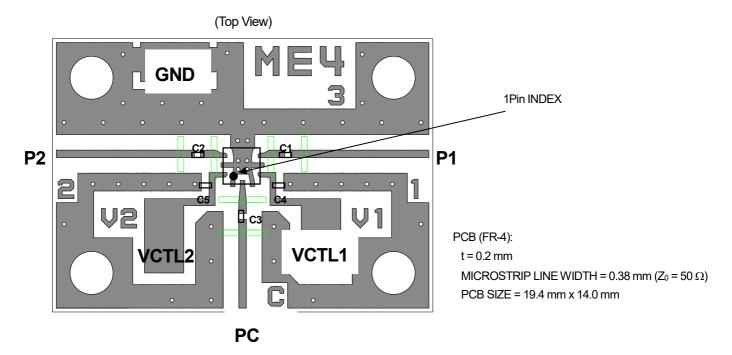
■ APPLICATION CIRCUIT



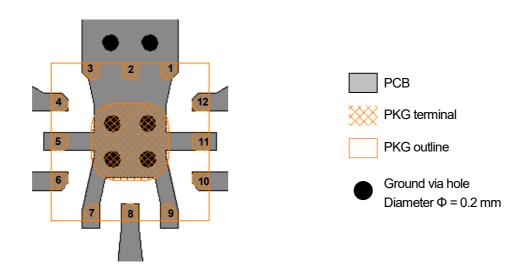
< PARTS LIST>

	Value		
Part ID	List 1	List 2	Notes
	f = 0.3 to 2.0 GHz	f = 2.0 to 6.0 GHz	
C1 to C3	100 pF	27 pF	MURATA (GRM03)
C4, C5	10 pF	10 pF	MURATA (GRM03)

■ EVALUATION BOARD



■ PCB LAYOUT GUIDELINE (EQFN12-E4)

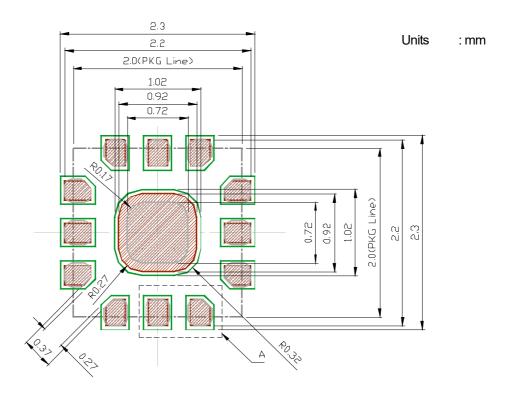


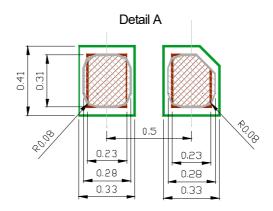
PRECAUTIONS

- [1] The DC blocking capacitors should be placed at RF terminals. Please choose appropriate capacitance value at the application frequency.
- [2] For good RF performance, all GND terminals are must be connected to PCB ground plane of the substrate, and through holes for GND should be placed near the IC.
- [3] Please connect Exposed PAD to PCB ground plane of substrate, and through holes for ground should be placed under the IC.
- [4] Please place through holes under the IC as many as possible in order to improve thermal conduction.

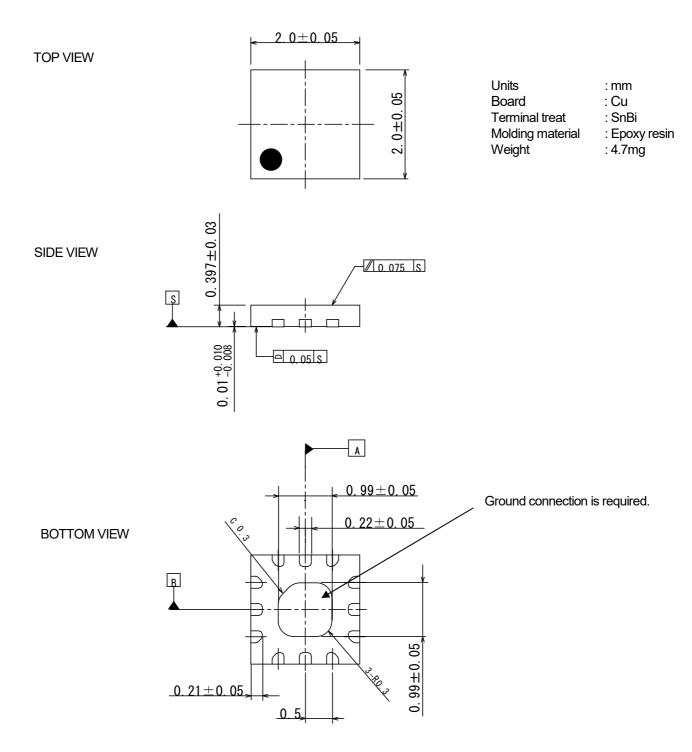
■ RECOMMENDED FOOTPRINT PATTERN (EQFN12-E4 PACKAGE Reference)

PKG: 2.0 mm x 2.0 mm Pin pitch: 0.5 mm : Land
: Mask (Open area) *Metal mask thickness: 100 μm
: Resist (Open area)





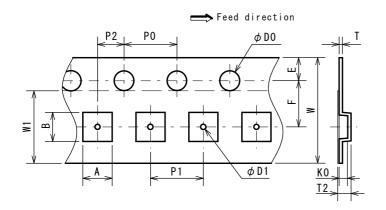
■ PACKAGE OUTLINE (EQFN12-E4)



■PACKING SPECIFICATION

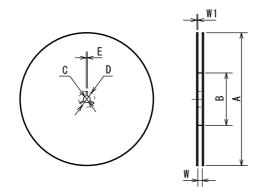
Unit: mm

TAPING DIMENSIONS



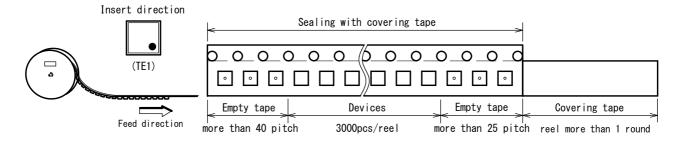
SYMBOL	DIMENSION	REMARKS
A	2.25±0.05	BOTTOM DIMENSION
В	2.25±0.05	BOTTOM DIMENSION
D0	1. 5 +0.1	
D1	0.5±0.1	
E	1.75±0.1	
F	3.5±0.05	
P0	4.0±0.1	
P1	4.0±0.1	
P2	2.0±0.05	
T	0.25 ± 0.05	
T2	1.00±0.07	
K0	0.65 ± 0.05	
W	8.0±0.2	
W1	5. 5	THICKNESS 0. 1max

REEL DIMENSIONS

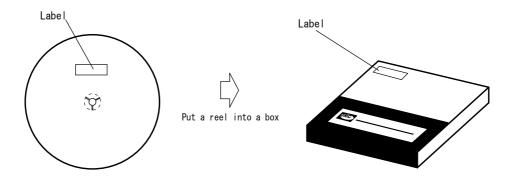


SYMBOL	DIMENSION
A	ϕ 180 $^{0}_{-1.5}$
В	φ 60 ⁺¹ ₀
С	φ 13±0.2
D	ϕ 21±0.8
E	2±0.5
W	9 +1
W1	1. 2

TAPING STATE



PACKING STATE



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- 8. Quality Warranty
 - 8-1. Quality Warranty Period
 - In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
 - 8-2. Quality Warranty Remedies
 - When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.
 - Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
 - 8-3. Remedies after Quality Warranty Period
 - With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
- 9. Anti-radiation design is not implemented in the products described in this document.
- 10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
- 13. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



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